505967554 03/13/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT6014261

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHUN-WEN CHENG	03/06/2020
CHUN YIN TSAI	03/03/2020
CHIA-HUA CHU	03/04/2020

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16818881

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NAME OF SUBMITTER:	ANTHONY KING
SIGNATURE:	/Anthony King/
DATE SIGNED:	03/13/2020

Total Attachments: 2

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PATENT 505967554 REEL: 052113 FRAME: 0338

Signature of Assignor

Name of Witness (official)

Signature of Witness (optional)

ASSIGNMENT

WHEREAS, I(we), <u>CHENG, CHUN-WEN</u>, <u>TSAI, CHUN YIN</u> and <u>CHU, CHIA-HUA</u> whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

SEMICONDUCTOR STRUCTURE AND METHOD FOR MANUFACTURING THEREOF

(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent /Utility Patent

is executed on even date herewith unless at least one of the United States Design Patent was	te following is c	hecked:	
□ executed on:			
	rial No.:		
established by PCT International Patent Applicat		filed:	designating the
United States of America			
☐ issued onas U.S. Patent No	5.5 <u></u>	**************	
WHEREAS, TAIWAN SEMICONDUCTOR MAN address is NO.8, LI-HSIN RD. 6, HSINCHU Shereinafter referred to as ASSIGNEE, is desirous of acquire the United States and its territorial possessions;	SCIENCE PA ring the entire ri	RK, HSINC ght, title and in	HU, TAIWAN, R.O.C. terest in and to the same in
NOW, THEREFORE, for good and valuable consider ASSIGNOR, by these presents do sell, assign and transfer and to said INVENTION and application throughout the Patent granted on any division, continuation, continuation terms for which the same may be granted, including all p	unto said ASSIC United States on-in-part and rei	ONEE, the entire of America, inc ssue of said app	e right, title, and interest in cluding any and all Letters olication for the full term of
ASSIGNOR further covenants that no assignments, e or entered into which would conflict with this Assignment		or encombranc	e has been or will be made
ALSO, ASSIGNOR hereby agrees to execute any documents prosecution and maintenance of said application and invention, including additional documents that missaid INVENTION, all without further consideration. As ASSIGNEE'S expense, to identify and communicate to Assoncerning the INVENTION that are within ASSIGNOR'S petestimony on behalf of ASSIGNEE that lawfully may be maintenance, litigation and defense of any patent applies instrument. ASSIGNOR'S obligations under this instadministrators and other legal representatives.	or any other pat ay be required to SIGNOR also ag SIGNEE at ASSIGNEE cossession or con the required of the lication or pates	ent application of affirm the rigrees, without fine E's request trol, and to pro ASSIGNOR in and compasse	(s) in the United States for ghts of ASSIGNEE in and to arther consideration and a documents and information wide further assurances and respect of the prosecution d within the terms of this
ALSO, ASSIGNOR hereby authorizes and requests the and all Letters Patent referred to above to ASSIGNEE, as the same, for ASSIGNEE'S sole use and behoof; and for the successors, to the full end of the term for which such L same would have been held by ASSIGNOR had this assign	the ASSIGNEE of ne use and behoo citers Patent ma	the entire right of of ASSIGNEE my be granted.	t, title and interest in and to 'S legal representatives and
Assigner Name CHENG, CHUN-WEN			IE 100, JIAFENG 1ST NCHU COUNTY 302,

PATENT REEL: 052113 FRAME: 0339

TAIWAN (R.O.C.)

Name of Witness (optional)

Signature of Witness (Optional)

Date of Signature

Assignor Name TSAI, CHUN YIN	Adibress NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK, HSINCHU, TAIWAN (R.O.C.)
Signature of Assignor (X) 754 L. churt Yin.	Date of Signature (X) zo2 v / v³ / v }
Name of Witness (aptional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name CHU, CHIA-HUA CHU, CHIA- HUA	Address NO.1, LANE 176, AIKOU 6TH ST., ZHUBEI CITY, HSINCHU COUNTY 302, TAIWAN (R.O.C.)
Signature of Assignor (X) CHU, CHTA - HUA	Date of Signature (X) 2025/3/4
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)